

### **UVC Emitting Diode in SMD Package**



#### **DESCRIPTION**

VLMU35CB2.-275-120 is a ceramic based standard power UVC LED with quartz window for long life time. The package size is  $3.45 \text{ mm} \times 3.45 \text{ mm} \times 1.78 \text{ mm}$  and the radiant power typically 10 mW at 100 mA in a wavelength range of 270 nm to 285 nm.

#### PRODUCT GROUP AND PACKAGE DATA

Product group: LEDPackage: SMD ceramic

Product series: standard power UV LED

• Angle of half intensity: ± 60°

· Lead-finishing: Au

#### **FEATURES**

- Ceramic SMT package with quartz window
- Dimension (L x W x H) in mm: 3.45 x 3.45 x 1.78
- DC forward current: up to 150 mA
- Radiant power (typ.): 10 mW at 100 mA and 14.1 mW at 150 mA
- Leads / terminations finish: gold plated (Au)
- Reflow soldering method
- MSL 3 according to J-STD-020
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

# Pb-free



COMPLIANT

FREE GREEN

#### **APPLICATIONS**

- Sterilization
- Medical application
- Sensing of gases, germs, DNA, ...

#### **SAFETY ADVICES**

These LEDs emit very strong UV radiation during operation. Do not look directly into the LED light when in operation as UV radiation can harm your eyes. To prevent inadequate exposure, wear protective eyewear. If LEDs are embedded in devices, please indicate warning labels. Avoid exposure to skin or other tissue during operation. Keep out of the reach of children. Take appropriate precautions around pets and other living organisms to avoid UV exposure.

PARTS TABLE														
PART	COLOR	RADIANT POWER (mW)		at WAVELENGTH (nm)		GTH	at I <sub>F</sub>	FORWARD VOLTAGE (V)		at I <sub>F</sub>	TECHNOLOGY			
		MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(mA)	
VLMU35CB20-275-120	Ultraviolet	7	10	-	100	270	277	285	100	5.0	6.5	7.0	100	AlGaN

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified) <b>VLMU35CB2275-120</b>							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
DC forward current		I <sub>F</sub>	150	mA			
Power dissipation		P <sub>V</sub>	1.1	W			
Reverse voltage Not designed for reverse operation				n			
Electrostatic discharge	HBM: MIL-STD-883 C 3B	ESD	2000	V			
Junction temperature		Tj	+90	°C			
Operating temperature range		T <sub>amb</sub>	-40 to +80	°C			
Storage temperature range		T <sub>stg</sub>	-40 to +100	°C			
Solder temperature		T <sub>sol</sub>	260	°C			



OPTICAL AND ELECTRICAL CHARACTERISTICS ( $T_{amb} = 25$ °C, unless otherwise specified) VLMU35CB2275-120, ULTRAVIOLET							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Forward voltage	I <sub>F</sub> = 100 mA	$V_{F}$	5.0	6.5	7.0	V	
	I <sub>F</sub> = 20 mA		-	2.4	-	mW	
Radiant power	I <sub>F</sub> = 100 mA	<b>ф</b> е	7	10	-		
	I <sub>F</sub> = 150 mA		-	14.1	-		
Ratio of radiant intensity/radiant power	I <sub>F</sub> = 100 mA	l <sub>e</sub> /φ <sub>e</sub>	-	0.26	-	sr-1	
Peak wavelength	I <sub>F</sub> = 100 mA	$\lambda_{p}$	270	277	285	nm	
Angle of half intensity	I <sub>F</sub> = 100 mA	φ	-	± 60	-	0	
Thermal resistance junction to solder-point	Soldered on 20 x 20 x 1.7 (in mm) Al MCPCB	R <sub>thJS</sub>	-	24.4	-	K/W	

#### Note

• Tolerances:  $\pm$  11 % for  $\varphi_e,\,\pm$  0.1 V for  $V_F,\,\pm$  3 nm for  $\lambda_p$ 

RADIANT POWER CLASSIFICATION (I <sub>F</sub> = 100 mA)						
GROUP	UNIT					
X1	7	9				
X2	9	11				
Х3	11	13	mW			
X4	13	15				
X5	15	-				

PEAK WAVELENGTH CLASSIFICATION (I <sub>F</sub> = 100 mA)							
GROUP MIN. MAX. UNIT							
W1	270	285	nm				

FORWARD VOLTAGE CLASSIFICATION (I <sub>F</sub> = 100 mA)						
GROUP	MIN.	MAX.	UNIT			
VZ	5.0	5.5				
V0	5.5	6.0	V			
V1	6.0	6.5	- V			
V2	6.5	7.0				

#### Note

In order to ensure availability, single groups for radiant intensity, wavelength, and forward voltage will not be orderable. Only one group for
radiant intensity, wavelength, and forward voltage will be shipped in any one reel

### TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

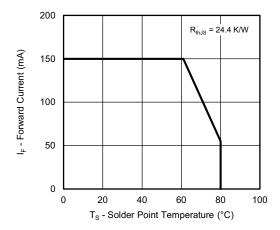


Fig. 1 - Maximum Forward Current vs. Solder Point Temperature

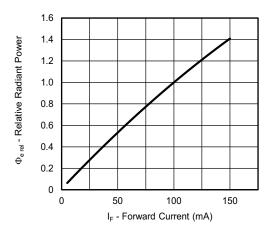


Fig. 2 - Relative Radiant Power vs. Forward Current

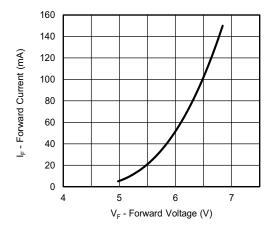


Fig. 3 - Forward Current vs. Forward Voltage

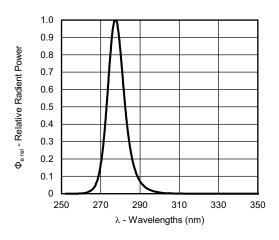


Fig. 4 - Relative Radiant Power vs. Wavelength

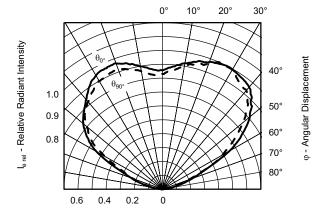


Fig. 5 - Relative Radiant Intensity vs. Angular Displacement

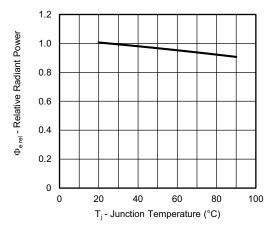


Fig. 6 - Relative Radiant Power vs. Junction Temperature



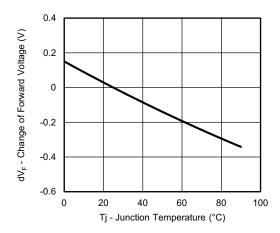
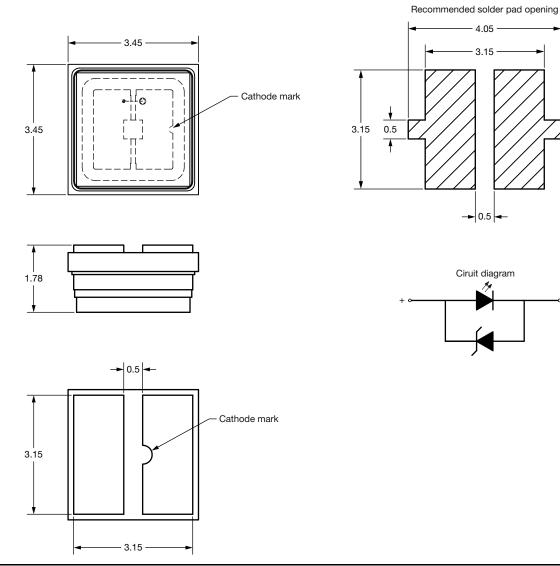


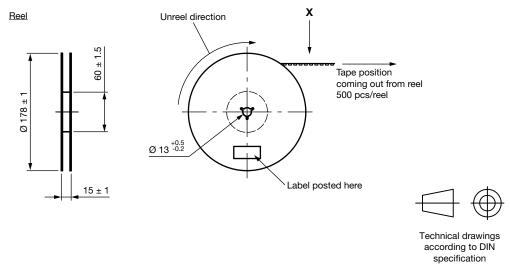
Fig. 7 - Change of Forward Voltage vs. Junction Temperature

### **PACKAGE DIMENSIONS** in millimeters

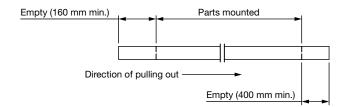


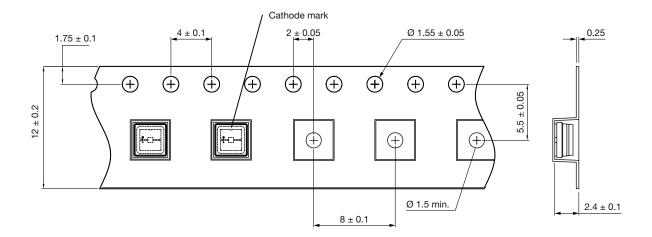
Rev. 1.0, 09-Sep-2020 4 Document Number: 80232

### TAPE AND REEL DIMENSIONS in millimeters



Leader and trailer tape





### **SOLDERING PROFILE**

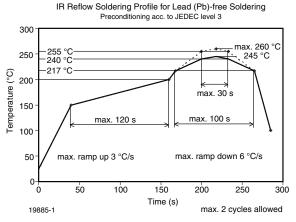
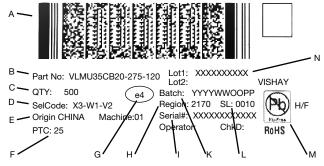


Fig. 8 - Vishay Lead (Pb)-free Reflow Soldering Profile (according to J-STD-020C)

### **BAR CODE PRODUCT LABEL** (example only)



A. 2D barcode

B. Part No: Vishay part number

C. QTY: quantity

D. SelCode: selection bin code

E. Country of origin

F. PTC: production plant code

G. Termination finish

H. Region code

I. Serial#: serial number

K. Batch number: year, week, country code, plant code

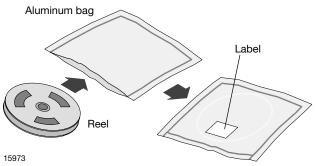
L. SL: sales location

M. Environmental symbols: RoHS, lead (Pb)-free, halogen-free

N. Lot numbers

### **DRY PACKING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



#### FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

#### RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

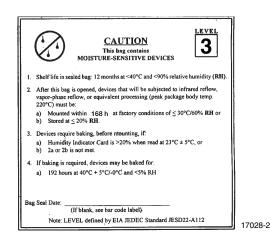
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

24 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JESD22-A112 level 3 label is included on all dry bags.



Example of JESD22-A112 level 3 label





### **ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

## VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



### **Legal Disclaimer Notice**

Vishay

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